

Abstract of the Disclosure

A method for flexible mounting piezoelectric devices at a spaced distance from a PC board by conductive adhesive so as to provide support to the device sufficient to withstand 50g on three axes for 11 ms with minimal adverse effect on the operation and performance of the assembled structure. Also disclosed is a piezoelectric device flexibly mounted at a spaced distance from a PC board by conductive adhesive so as to provide support to the device sufficient to withstand 50g on three axes for 11 ms with minimal adverse effect on the operation and performance of the device.